

### Description

The DFS600HF17I3C2 is a Half Bridge SiC MOSFET Power Module. It integrates high performance SiC MOSFET chips designed for the applications such as Motor drives and Renewable energy.



### Features

- Blocking voltage 1700V
- $R_{DS(on)} = 3.4m\Omega @ T_j = 25^\circ C, V_{GS} = 15V$
- Low thermal resistance with Si<sub>3</sub>N<sub>4</sub> AMB
- 175°C maximum junction temperature
- Low Inductive Design
- Thermistor inside
- Pressfit terminal
- Copper base size: 79mmx62mm

### Applications

- Motor Drives
- Servo Drives
- UPS Systems
- Smart-Grid/Grid-Tied Distributed Generation

### Circuit diagram

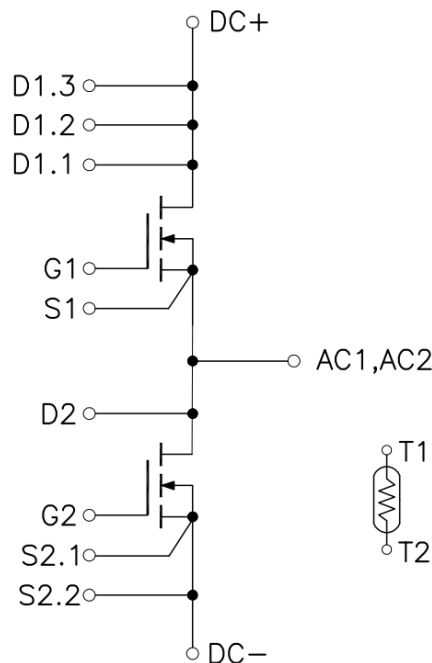


Figure 1. Out drawing & circuit diagram for DFS600HF17I3C2

Note: Please use S2.1 for the low side drive signal and do not connect it to S2.2 which is power terminal

### Pin Configuration and Marking Information

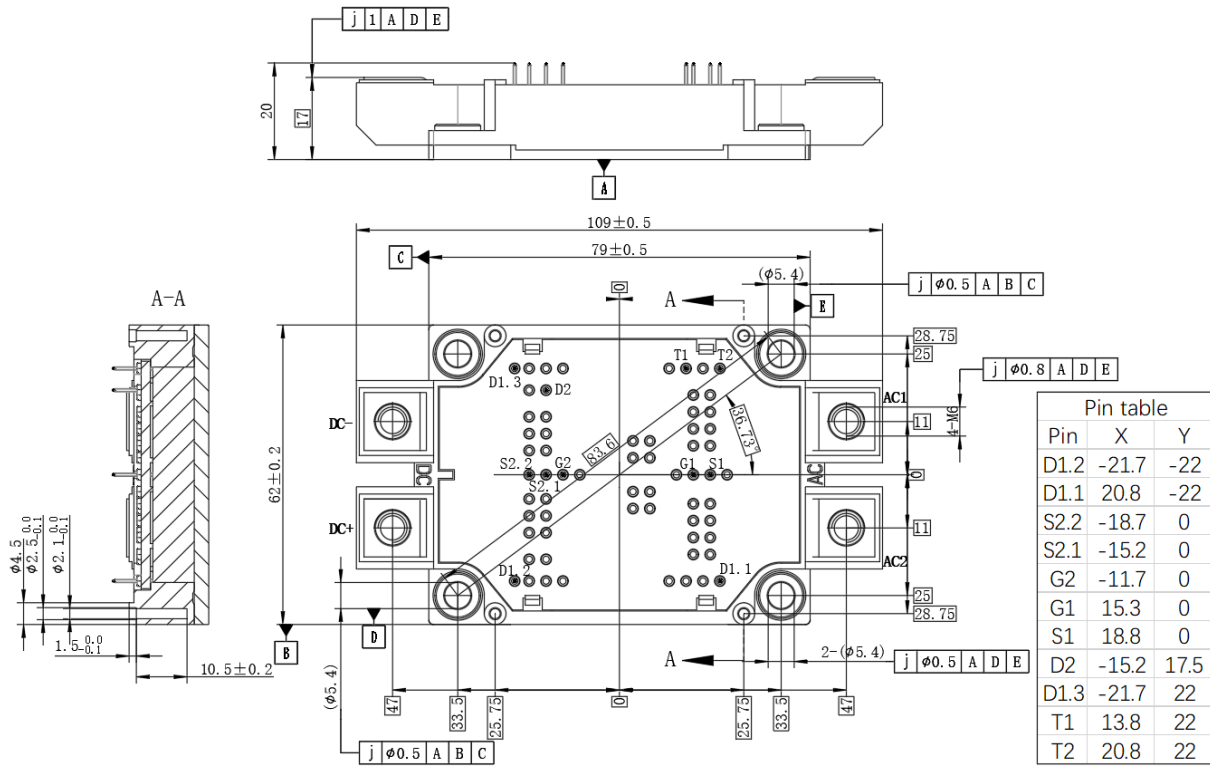


Figure 2. Pin configuration

### Module

Parameter	Conditions	Value	Unit
Isolation Voltage	RMS, f =50Hz, t =1min	4.0	KV
Material of module baseplate	-	Cu	-
Creepage distance	terminal to heatsink terminal to terminal	14.5 10	mm
Clearance	terminal to heatsink terminal to terminal	12.5 10	mm
CTI	-	600	-
Module lead resistance, terminals–chip	T <sub>c</sub> =25°C	0.5	mΩ
Mounting torque for module mounting	M5, M6	3 to 6	Nm
Weight	-	250	g

### Maximum Ratings (T<sub>j</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>DSS</sub>	Drain-Source Voltage	G-S Short	1700	V
V <sub>GSS</sub>	Gate-Source Voltage (+)	D-S Short	20	V
V <sub>GSS</sub>	Gate-Source Voltage (-)	D-S Short	-10	V
V <sub>GSSSurge</sub>	G-S Voltage(t <sub>surge</sub> < 300nsec)	D-S Short, Note1	-10 to 20	V
I <sub>DS</sub>	DC Continuous Drain Current	T <sub>f</sub> = 25°C, V <sub>GS</sub> = 15V	600	A
I <sub>DS</sub>	DC Continuous Drain Current	T <sub>f</sub> = 80°C, V <sub>GS</sub> = 15V	475	A
I <sub>SD</sub>	Source (Body diode) Current	T <sub>f</sub> = 25°C, with ON signal	600	A
I <sub>SD</sub>	Source (Body diode) Current	T <sub>f</sub> = 80°C, with ON signal	475	A
I <sub>DSM</sub>	Pulse Forward Current	T <sub>C</sub> = 25°C, Pulse width = 1ms, V <sub>GS</sub> = 15V, Note2	1200	A
P <sub>tot</sub>	Total Power Dissipation	T <sub>C</sub> = 25°C	3750	W
T <sub>jmax</sub>	Max Junction Temperature	-	175	°C
T <sub>jop</sub>	Operating junction Temperature	-	-40 to 150	°C
T <sub>stg</sub>	Storage Temperature	-	-40 to 125	°C

Note1: Recommended Operating Value, -4V/+15V, -5V/+15V

Note2: Pulse width limited by maximum junction temperature

### NTC characteristics

Symbol	Parameter	Condition	Value			Unit
			Min.	Typ.	Max.	
R <sub>25</sub>	Resistance	T <sub>C</sub> = 25°C	-	5	-	kΩ
ΔR/R	Deviation of R <sub>100</sub>	T <sub>C</sub> = 100°C, R <sub>100</sub> = 493Ω	5	-	5	%
P <sub>25</sub>	Power dissipation	T <sub>C</sub> = 25°C	-	-	20	mW
B <sub>25/50</sub>	B-value	R <sub>2</sub> = R <sub>25</sub> exp [B <sub>25/50</sub> (1/T <sub>2</sub> - 1/(298,15 K))]	-	3375	-	K
B <sub>25/80</sub>	B-value	R <sub>2</sub> = R <sub>25</sub> exp [B <sub>25/80</sub> (1/T <sub>2</sub> - 1/(298,15 K))]	-	3411	-	K
B <sub>25/100</sub>	B-value	R <sub>2</sub> = R <sub>25</sub> exp [B <sub>25/100</sub> (1/T <sub>2</sub> - 1/(298,15 K))]	-	3433	-	K

### MOSFET Electrical characteristics (T<sub>j</sub> = 25°C unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max		
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 160μA	1700	-	-	V	
I <sub>DSS</sub>	Zero gate voltage drain Current	V <sub>DS</sub> = 1700V, V <sub>GS</sub> = 0V	-	4	160	μA	
V <sub>GS(th)</sub>	Gate-source threshold Voltage	I <sub>D</sub> = 240mA	T <sub>j</sub> = 25°C	1.8	2.70	-	V
		V <sub>DS</sub> = V <sub>GS</sub>	T <sub>j</sub> = 175°C	-	1.90	-	V
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = 15V, V <sub>DS</sub> = 0V, T <sub>j</sub> = 25°C	-	-	1200	nA	
R <sub>DS(on)</sub> (Chip)	Static drain-source	I <sub>D</sub> = 600A	T <sub>j</sub> = 25°C	-	3.4	5.2	mΩ
	On-state resistance	V <sub>GS</sub> = 15V	T <sub>j</sub> = 175°C	-	7.7	-	mΩ
V <sub>DS(on)</sub> (Chip)	Static drain-source	I <sub>D</sub> = 600A	T <sub>j</sub> = 25°C	-	2.04	3.12	V
	On-state Voltage	V <sub>GS</sub> = 15V	T <sub>j</sub> = 175°C	-	4.62	-	V
C <sub>iss</sub>	Input Capacitance	V <sub>D</sub> = 1000V, V <sub>GS</sub> = 0V f = 1MHz, V <sub>AC</sub> = 25mV	-	45.7	-	nF	
C <sub>oss</sub>	Output Capacitance		-	1.23	-	nF	
C <sub>rss</sub>	Reverse transfer Capacitance		-	0.22	-	nF	
Q <sub>G</sub>	Total gate charge	V <sub>DD</sub> = 1000V, I <sub>D</sub> = 450A, V <sub>GS</sub> = -5/+15V	-	1536	-	nC	
R <sub>Gint</sub>	Internal Gate Resistance	T <sub>j</sub> = 25°C	-	0.32	-	Ω	
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 900V I <sub>D</sub> = 600A V <sub>GS</sub> = +15/-4V R <sub>G(on)</sub> = 6.8Ω R <sub>G(off)</sub> = 6.8Ω Inductive load switching operation	T <sub>j</sub> = 25°C	-	229	-	ns
			T <sub>j</sub> = 150°C	-	183	-	
t <sub>r</sub>	Rise time		T <sub>j</sub> = 25°C	-	169	-	ns
			T <sub>j</sub> = 150°C	-	138	-	
t <sub>d(off)</sub>	Turn-off delay time		T <sub>j</sub> = 25°C	-	766	-	ns
			T <sub>j</sub> = 150°C	-	922	-	
t <sub>f</sub>	Fall time		T <sub>j</sub> = 25°C	-	125	-	ns
			T <sub>j</sub> = 150°C	-	156	-	
E <sub>on</sub>	Turn-on power dissipation		T <sub>j</sub> = 25°C	-	92.4	-	mJ
			T <sub>j</sub> = 150°C	-	84.2	-	
E <sub>off</sub>	Turn-off power dissipation	T <sub>j</sub> = 25°C	-	99.8	-	mJ	
		T <sub>j</sub> = 150°C	-	107.9	-		
R <sub>th(j-c)</sub>	FET Thermal Resistance	Junction to Case	-	0.040	-	K/W	
R <sub>th(c-f)</sub>	Contact thermal Resistance	With thermal conductive grease, Note4	-	0.015	-	K/W	

Note4: Assumes Thermal Conductivity of grease is 0.9W/m · K and thickness is 50μm.

### Body Diode Electrical characteristics (T<sub>j</sub>=25°C unless otherwise specified, chip)

Symbol	Item	Condition	Value			Unit	
			Min.	Typ.	Max.		
V <sub>SD</sub>	Body Diode Forward Voltage	V <sub>GS</sub> = -4V I <sub>SD</sub> = 600A	T <sub>j</sub> = 25°C	-	5.6	-	V
			T <sub>j</sub> = 150°C	-	5.1	-	
T <sub>rr</sub>	Reverse recovery time	V <sub>RR</sub> = 900V, I <sub>D</sub> = 600A MOSFET side:	T <sub>j</sub> = 25°C	-	58	-	ns
			T <sub>j</sub> = 150°C	-	191	-	
Q <sub>rr</sub>	Reverse recovery charge	V <sub>GS</sub> = +15/-4V R <sub>G(on)</sub> = R <sub>G(off)</sub> = 6.8Ω	T <sub>j</sub> = 25°C	-	3.37	-	uC
			T <sub>j</sub> = 150°C	-	19.38	-	
E <sub>rr</sub>	Diode switching power dissipation	Inductive load switching operation	T <sub>j</sub> = 25°C	-	0.68	-	mJ
			T <sub>j</sub> = 150°C	-	7.96	-	

### Test Conditions

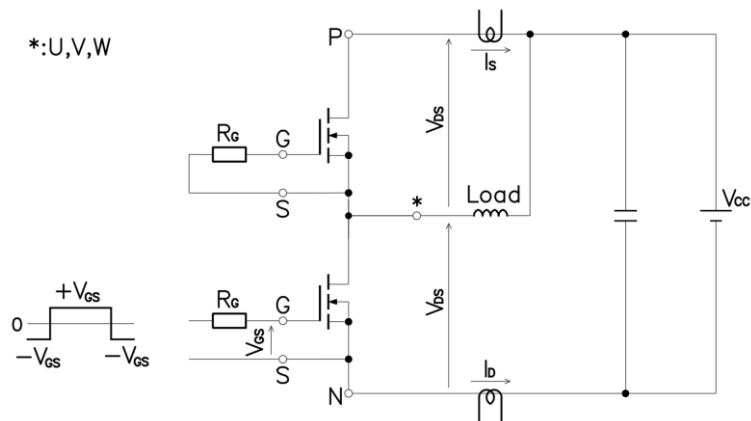


Figure 3. Switching time measure circuit

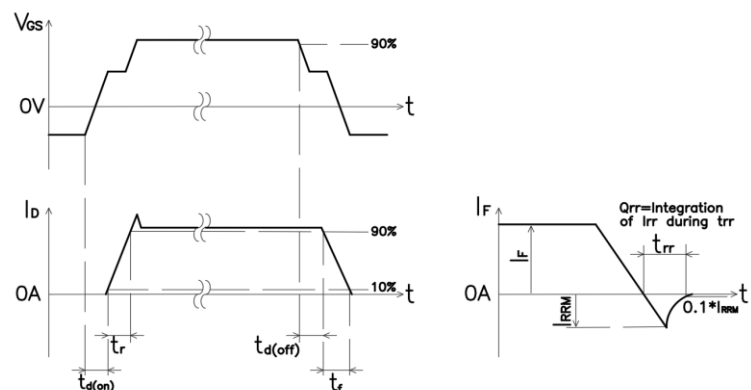


Figure 4. Switching time definition

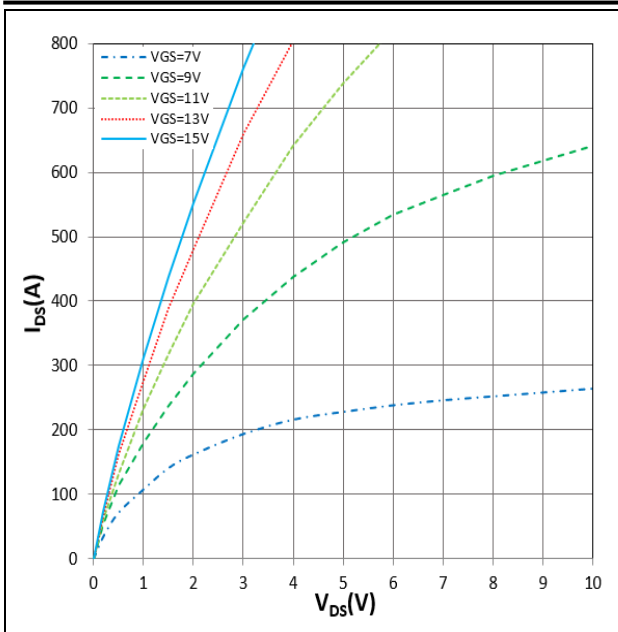


Figure 5.  $I_{DS}$  vs  $V_{DS}$   
 $T_j = 25^\circ\text{C}$ ,  $V_{GS}$  parameter

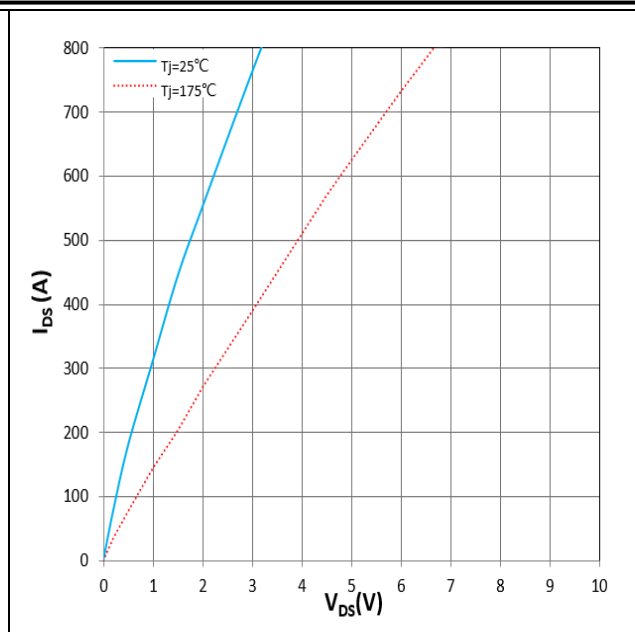


Figure 6.  $I_{DS}$  vs  $V_{DS}$   
 $V_{GS} = 15\text{V}$ ,  $T_j$  parameter

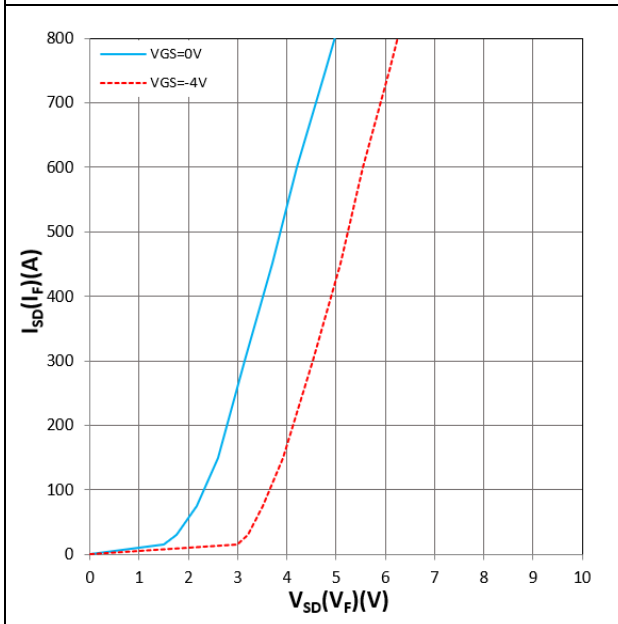


Figure 7.  $I_{SD}(I_F)$  vs  $V_{SD}(V_F)$   
 $T_j = 25^\circ\text{C}$ ,  $V_{GS}$  parameter

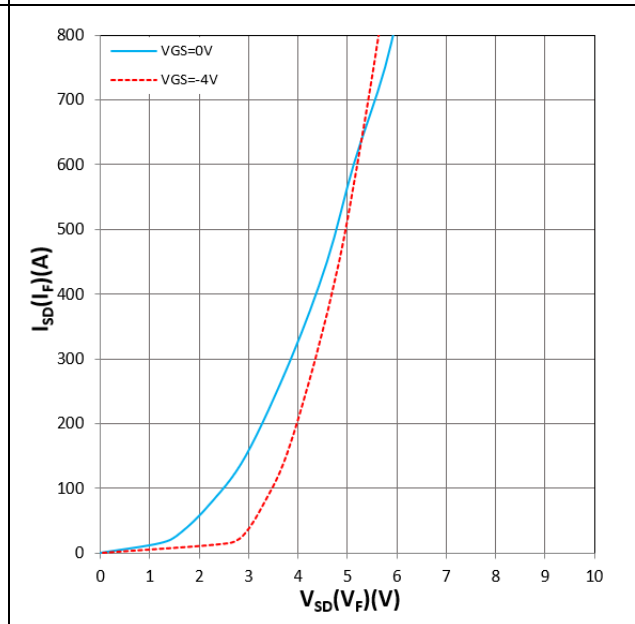


Figure 8.  $I_{SD}(I_F)$  vs  $V_{SD}(V_F)$   
 $T_j = 175^\circ\text{C}$ ,  $V_{GS}$  parameter

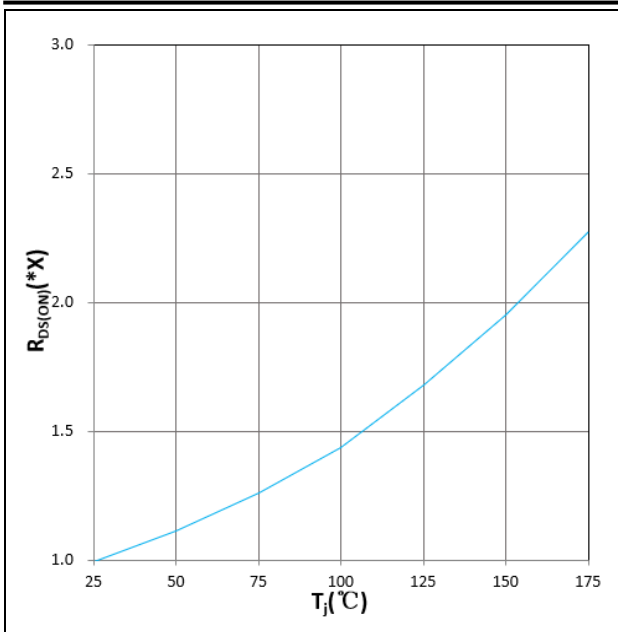


Figure 9.  $R_{DS(ON)}$  vs  $T_j$   
 $V_{GS}=+15V, I_D=600A, 1.0X=3.4m\Omega$

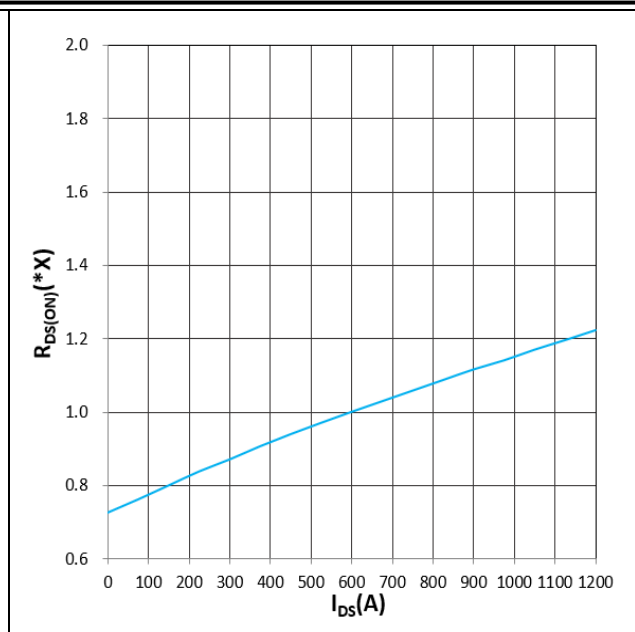


Figure 10.  $R_{DS(ON)}$  vs  $I_{DS}$   
 $T_j=25^\circ C, V_{GS}=+15V, 1.0X=3.4m\Omega$

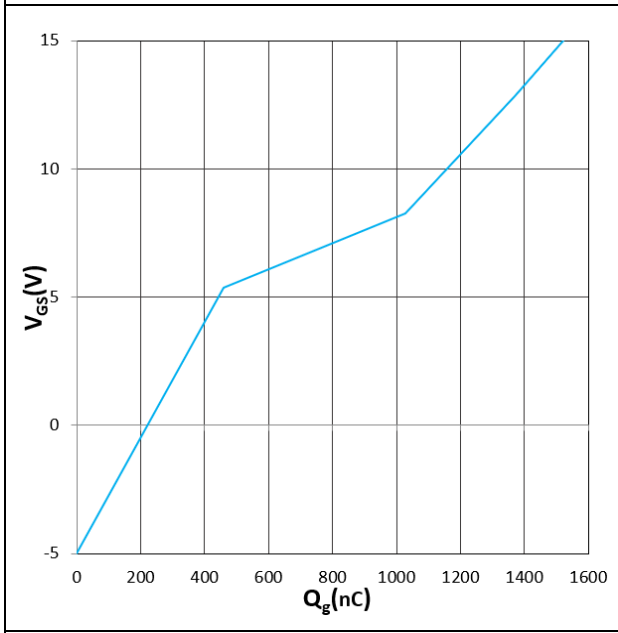


Figure 11.  $V_{GS}$  vs  $Q_g$   
 $T_j=25^\circ C, V_{DS}=1000V, I_D=450A$

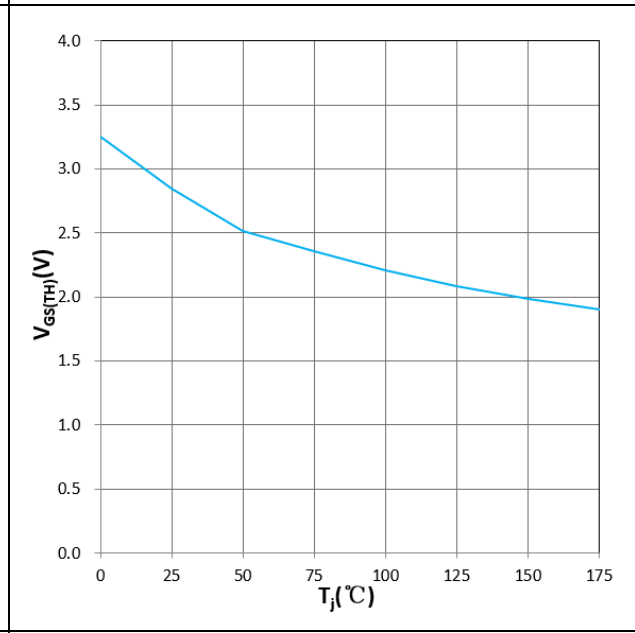


Figure 12.  $V_{GS(TH)}$  vs  $T_j$   
 $V_{GS}=V_{DS}, I_D=240mA$

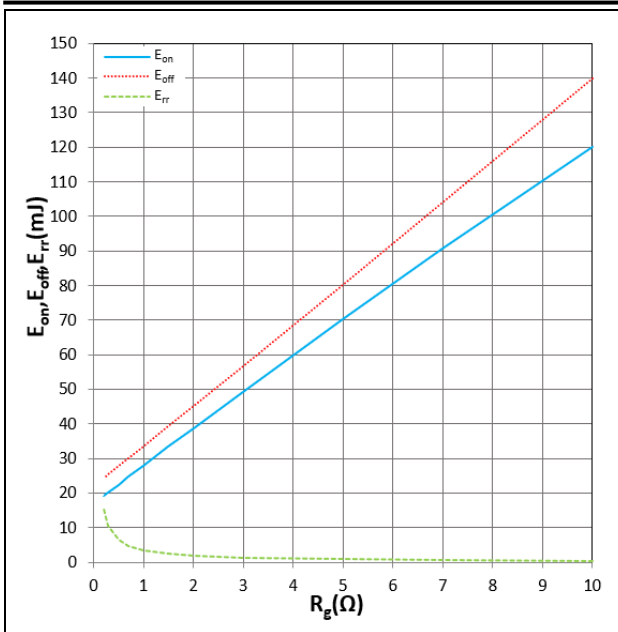


Figure 13.  $E_{on}$ ,  $E_{off}$ ,  $E_{rr}$  vs  $R_g$   
 $T_j=25^\circ\text{C}$ ,  $V_{CC}=900\text{V}$ ,  $V_{GS}=+15\text{V}/-4\text{V}$ ,  $I_D=600\text{A}$   
 Inductive Load

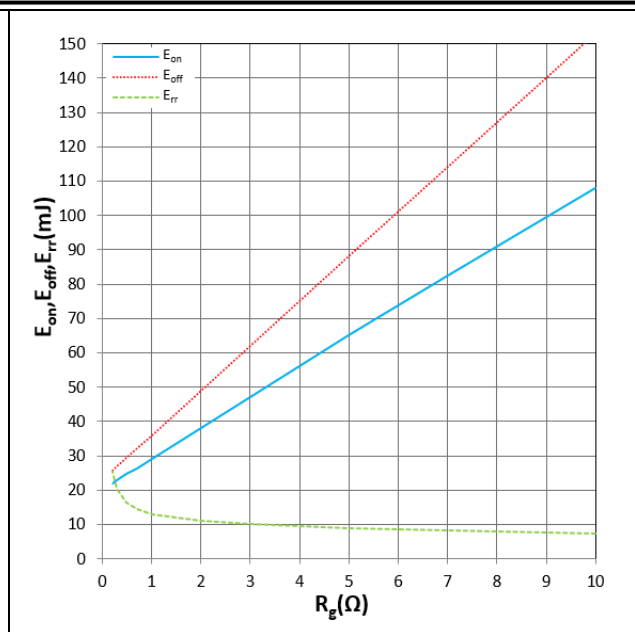


Figure 14.  $E_{on}$ ,  $E_{off}$ ,  $E_{rr}$  vs  $R_g$   
 $T_j=150^\circ\text{C}$ ,  $V_{CC}=900\text{V}$ ,  $V_{GS}=+15\text{V}/-4\text{V}$ ,  $I_D=600\text{A}$   
 Inductive Load

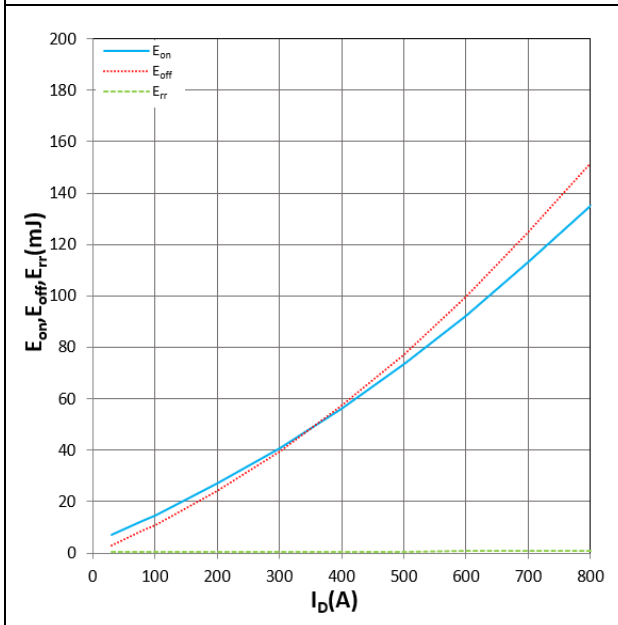


Figure 15.  $E_{on}$ ,  $E_{off}$ ,  $E_{rr}$  vs  $I_D$   
 $T_j=25^\circ\text{C}$ ,  $V_{CC}=900\text{V}$ ,  $V_{GS}=+15\text{V}/-4\text{V}$ ,  $R_g=6.8\Omega$   
 Inductive Load

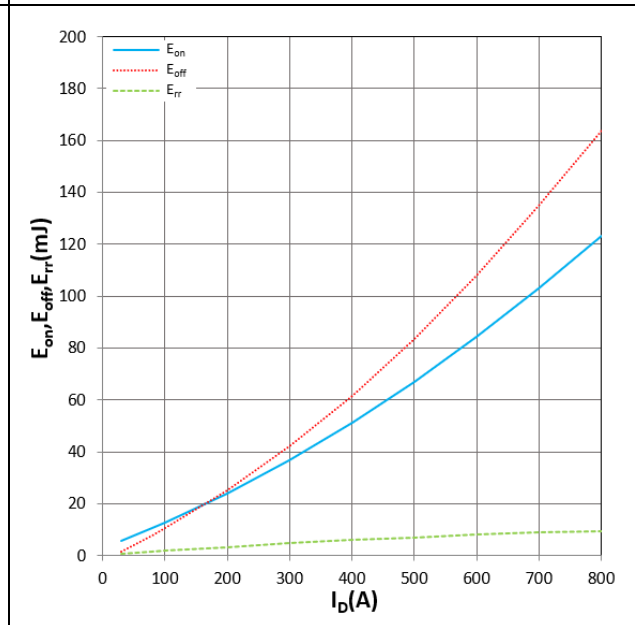


Figure 16.  $E_{on}$ ,  $E_{off}$ ,  $E_{rr}$  vs  $I_D$   
 $T_j=150^\circ\text{C}$ ,  $V_{CC}=900\text{V}$ ,  $V_{GS}=+15\text{V}/-4\text{V}$ ,  $R_g=6.8\Omega$   
 Inductive Load



### IMPORTANT NOTICE:

This product data sheet describes the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively under the terms and conditions of the supply agreement. There will be no guarantee or of any kind for the product and its characteristics.

The data contained in this document is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the product's suitability for the intended application and the completeness of the product data concerning such application.

Due to technical requirements, our product may contain dangerous substances. For information on the types in question, please contact the sales staff responsible for you.

Changes to this product data sheet are reserved.

Please contact the sales staff ([Sales@leapers-power.com](mailto:Sales@leapers-power.com)) for further information on the product, technology, delivery terms, conditions and prices.